

# **MOSFET**

# OptiMOS<sup>™</sup> 3 Power-Transistor, 100 V

#### **Features**

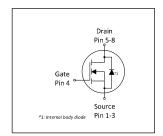
- Very low gate charge for high frequency applications
  Optimized for dc-dc conversion
  N-channel, normal level

- N-channel, normal level
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  150 °C operating temperature
  Pb-free lead plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target application
  Halogen-free according to IEC61249-2-21



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Parameter	Value	Unit					
<b>V</b> <sub>DS</sub>	100	V					
R <sub>DS(on),max</sub>	7	mΩ					
I <sub>D</sub>	92	A					











Type / Ordering Code	Package	Marking	Related Links
BSC070N10NS3 G	PG-TDSON-8	070N10NS	-



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Development	Comple al	Values			11	Nata / Tank One dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	92 58	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	368	Α	T <sub>C</sub> =25 °C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	_	160	mJ	$I_D$ =50 A, $R_{GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	114	W	T <sub>C</sub> =25 °C	
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56	

#### 2 Thermal characteristics

Thermal characteristics Table 3

Davamatar	Cymhal	Values			Unit	Nata / Tast Candition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	1.1	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	$R_{thJA}$	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm <sup>2</sup> cooling area <sup>3)</sup>	$R_{thJA}$	-	-	50	K/W	-	

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.
2) See Diagram 3

<sup>&</sup>lt;sup>3)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.



#### **Electrical characteristics**

at T<sub>j</sub>=25 °C, unless otherwise specified

**Static characteristics** Table 4

Demonstra	C b l		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2	2.7	3.5	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =75 μA	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.01 10	1 100	μΑ	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	6.3 8	7 14	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A V <sub>GS</sub> =6 V, I <sub>D</sub> =25 A	
Gate resistance	R <sub>G</sub>	-	1.5	-	Ω	-	
Transconductance	$g_{fs}$	36	72	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =50 A	

Table 5 **Dynamic characteristics** 

Davamento	0	Values				N 1 17 10 1111	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance <sup>1)</sup>	Ciss	-	3000	4000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Output capacitance <sup>1)</sup>	Coss	-	520	690	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Reverse transfer capacitance	Crss	-	21	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz	
Turn-on delay time	$t_{ m d(on)}$	-	15	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	
Rise time	t <sub>r</sub>	-	10	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	
Turn-off delay time	$t_{ m d(off)}$	-	29	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	
Fall time	t <sub>f</sub>	-	8	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G}$ =1.6 $\Omega$	

Table 6 Gate charge characteristics<sup>2)</sup>

Davamatav	Cumbal	Values			Unit	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	13	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge	Q <sub>gd</sub>	-	7	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	12	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total <sup>1)</sup>	$Q_g$	-	42	55	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	4.3	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V	
Output charge <sup>1)</sup>	Qoss	-	55	73	nC	V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V	

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test <sup>2)</sup> See "Gate charge waveforms" for parameter definition

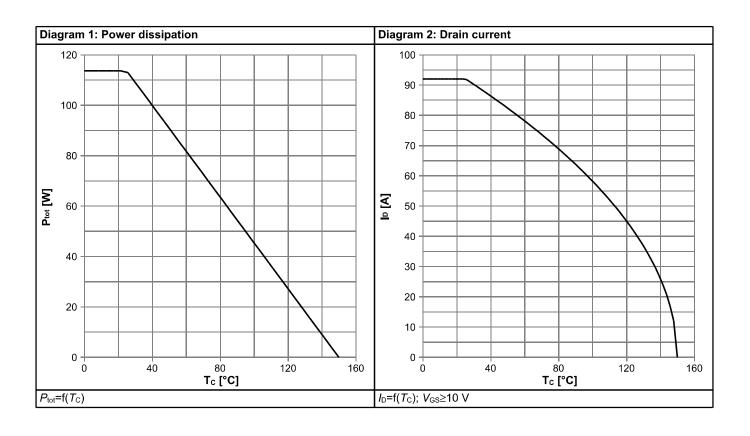


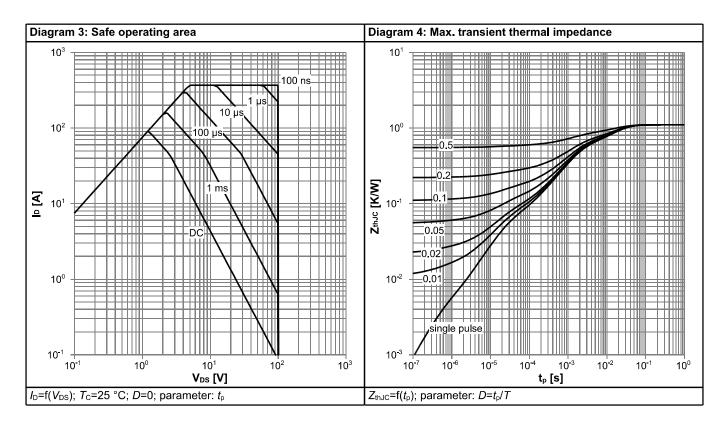
#### Table 7 Reverse diode

Davamatav	Cumah a l		Values			Nata / Tanak Camadikiana	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	90	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	368	А	T <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.89	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C	
Reverse recovery time	t <sub>rr</sub>	-	61	-	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge	Q <sub>rr</sub>	-	112	-	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

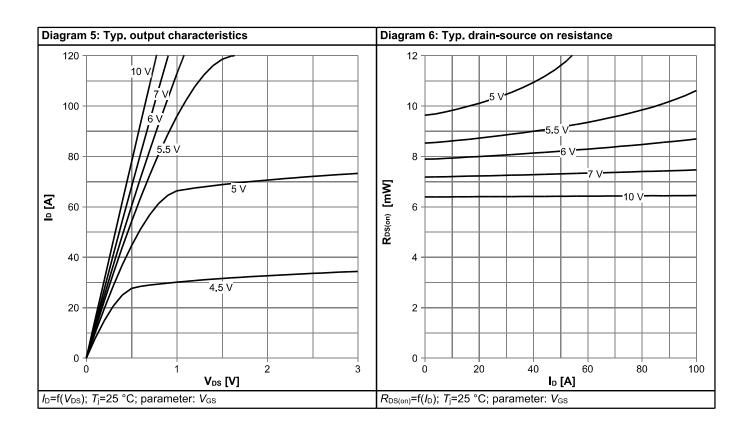


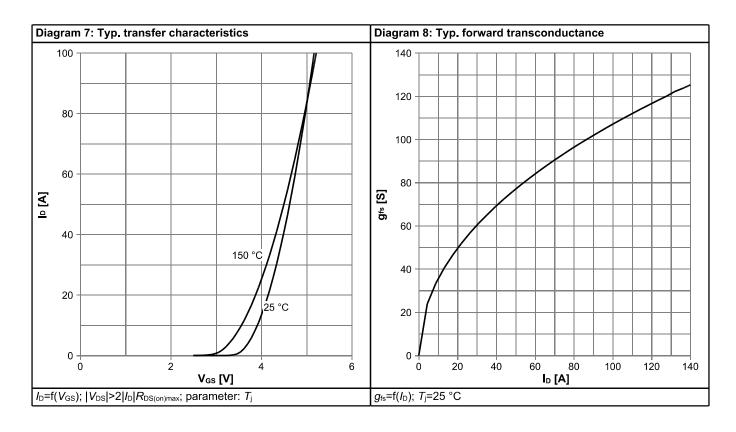
### 4 Electrical characteristics diagrams



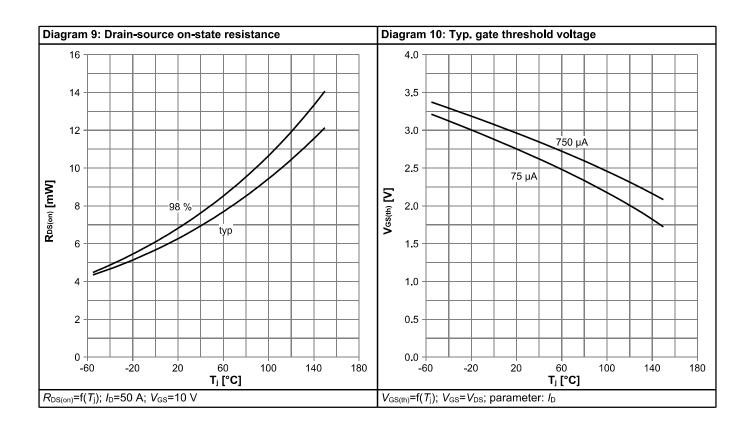


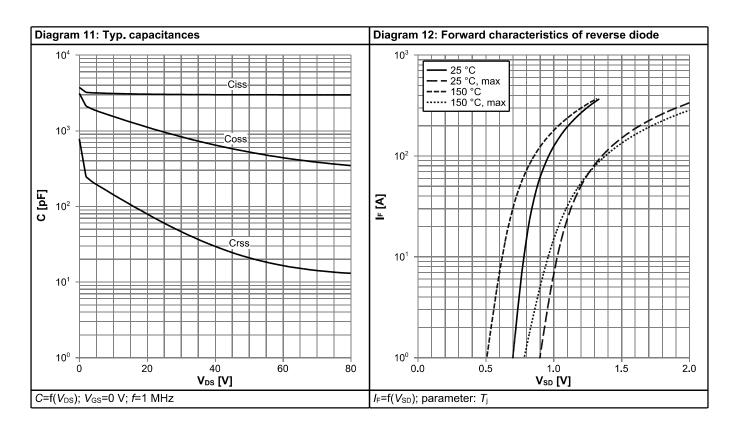




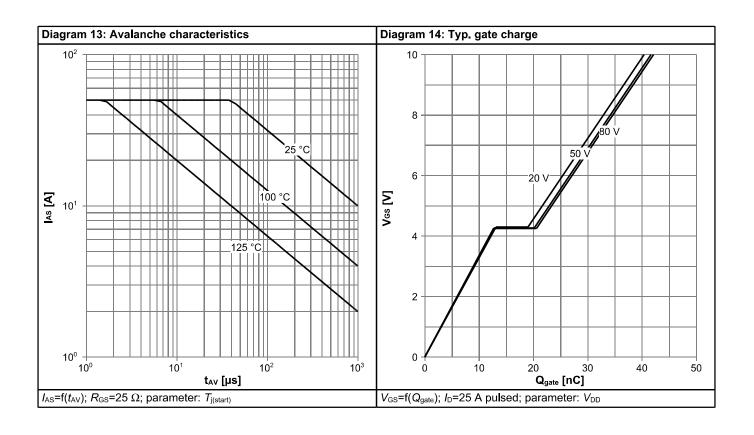


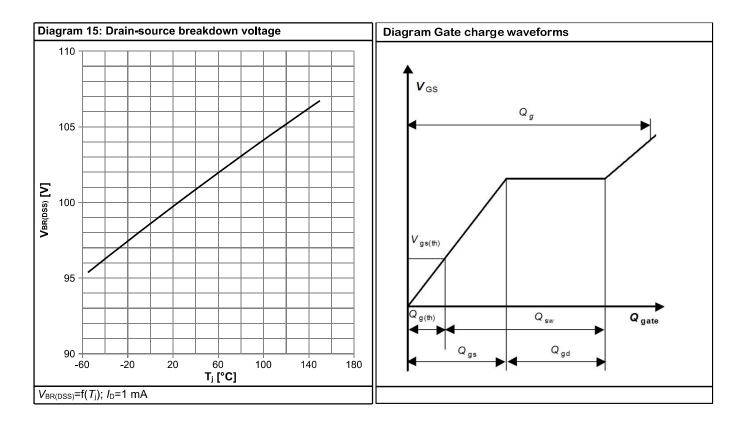






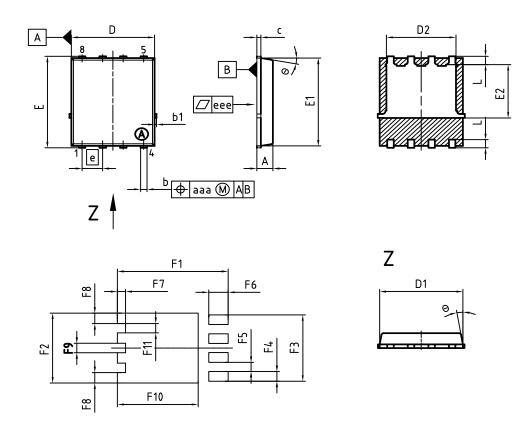








# 5 Package Outlines



D144	MILLI	METERS	INC	HES			
DIM	MIN	MAX	MIN	MAX			
Α	0.90	1.10	0.035	0.043			
b	0.34	0.54	0.013	0.021			
b1	0.02	0.22	0.001	0.008			
С	0.15	0.35	0.006	0.014			
D=D1	4.95	5.35	0.195	0.211			
D2	4.20	4.40	0.165	0.173			
E	5.95	6.35	0.234	0.250			
E1	5.70	6.10	0.224	0.240			
E2	3.40	3.80	0.134	0.150			
e	1.	27	0.050				
N		8	8				
L	0.45	0.65	0.018	0.026			
Θ	8.5°	11.5°	8.5°	11.5°			
aaa	0.	.25	0.0	)10			
eee	0.	.05	0.0	002			
F1	6.75	6.95	0.266	0.274			
F2	4.60	4.80	0.181	0.189			
F3	4.36	4.56	0.172	0.180			
F4	0.55	0.75	0.022	0.030			
F5	0.52	0.72	0.020	0.028			
F6	1.10	1.30	0.043	0.051			
F7	0.40	0.60	0.016	0.024			
F8	0.60	0.80	0.024	0.031			
F9	0.53	0.73	0.021	0.029			
F10	4.90	5.10	0.193	0.201			
F11	0.53	0.73	0.021	0.029			

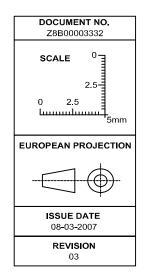


Figure 1 Outline PG-TDSON-8, dimensions in mm/inches



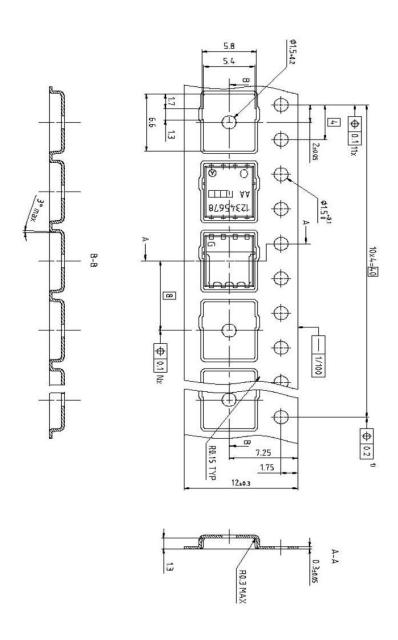


Figure 2 Outline Tape (PG-TDSON-8), dimensions in mm



#### **Revision History**

BSC070N10NS3 G

Revision: 2021-12-10, Rev. 2.2

Previous F	Revision	
Revision	Date	Subjects (major changes since last revision)
2.2	2021-12-10	Update current rating, footnotes and Vsd typ

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